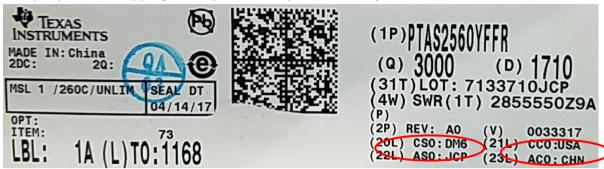
PCN Number:	20	1805010	01.1A		PC	N Da	te: Jul	y 10 2018
				10S6) and A	ssen	nbly/	Bump site	(JCAP) option for
Customer Contact:	<del>55/YZR/</del>	PCN Ma			De	pt:	Ou	ality Services
				Estima		•		te provided at
Proposed 1 <sup>st</sup> Ship Date:		Aug 3	Aug 3 2018 Availabilit			• · · · · · · · · · · · · · · · · · · ·		
<b>Change Type:</b>								
Assembly Site		☐ As	ssembly Pro	cess			Assembly	Materials
Design			ectrical Spe				Mechanic	al Specification
				oing/Labeling	9		Test Proc	ess
		W	afer Bump I	Material			Wafer Bu	mp Process
		W	afer Fab Ma	terials			Wafer Fal	o Process
		L Pa	art number o					
			PCN D	etails				
<b>Description of Chan</b>	ge:							
notification and modification and bolder devices will be 90 days.  Texas Instruments is	<b>Revision A</b> is to announce the <u>addition</u> of new devices that were not included on the original PCN notification and modify the title to describe the complete set of devices. These new devices are highlighted and <b>bolded</b> in the device list below. The expected first shipment date for these new devices will be 90 days from this notice for these newly added devices only.  Texas Instruments is pleased to announce the qualification of an additional fab (DMOS6) and assembly/bump (JCAP) site for the TAS2557YZR/T select Devices shown below.							
Curr	ent Fal	b Site			Ad	lditio	nal Fab S	ite
Fab Site Proce		Bump	Wafer	Rump			Wafer	
		Site	Diameter	Fab Site			Site	Diameter
RFAB LBC	:8 C	Clark-BP	300 mm	DMOS6	L	BC8	JCAP-E	300 mm
There are no material difference between devices currently manufactured and devices built with this manufacturing option.  Reason for Change:								
Continuity of Supply								
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):								
None								
Anticipated impact	on Mat	erial Dec	claration					
No Impact to the Material Declaration	No Impact to the Material Declarations or Product Content reports are driven from production data and will be available following the production			e production				
Changes to product identification resulting from this PCN:								
Fab Site Information:								
Chip Site Chip Site Origin Code (20L)		•	Chip Site Country Code (21L) Chip Site		Chip Site City			
RFAB RFB		USA Richard			Richardson			
DMOS6 DM6		<b>46</b>		US	A		Dallas	
Assembly Site Information:								
Assembly Site A	SSCIIIDIY	Jite Origii	II (ZZL) ASSE	andly Country	Coul	C (211	-, A	Sembly City

JCAP	JCP	CHN	Jiangyin
Clark	QAB	THA	Bangkok

Sample product shipping label (not actual product label)



# **Product Affected:**

SND032557YZR	SNP002557YZR	SNS022557YZR	TAS2557YZR
<b>SND032557YZT</b>	<b>SNP002557YZT</b>	<b>SNS022557YZT</b>	TAS2557YZT
SNM012557YZR	SNP002559YZR	<b>SNU042557YZR</b>	TAS2559YZR
<b>SNM012557YZT</b>	SNP002559YZT	<b>SNU042557YZT</b>	TAS2559YZT



# **Qualification Report**

# TAS2557/9 in (DMOS6/JCAP) Approve Date 19-Apr-2018

## **Product Attributes**

Attributes	Qual Device: <u>TAS2557YZ</u>	QBS Package Reference: <u>CD3230A0YFF</u>
Assembly Site	JCAP	JCAP
Package Family	DSBGA	DSBGA
Flammability Rating	UL 94 V-0	UL 94 V-0
Wafer Fab Supplier	DM6	RFAB
Wafer Process	LBC8LV	LBC7

<sup>-</sup> QBS: Qual By Similarity

## **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: <u>TAS2557YZ</u>	QBS Package Reference: CD3230A0YFF
ED	Electrical Characterization	Per Datasheet Parameters	-	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	1/77/0
HBM	ESD - HBM	2500 V	-	-
CDM	ESD - CDM	1500 V	-	-
HTOL	Life Test, 125C	1000 Hours	-	1/77/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	-	3/231/0
SBS	Bump-Shear		1/36/0	3/150/0
TC	Temperature Cycle, -55/125C	700 Cycles	1/77/0	3/231/0
UHAST	Unbiased HAST, 130C/85%RH	96 Hours	1/77/0	3/231/0

<sup>-</sup> Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

<sup>-</sup> Qual Device TAS2557YZ is qualified at LEVEL1-260C

<sup>-</sup> The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours - The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

<sup>-</sup> The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/



## **Qualification Report**

# TAS2557/9 in (RFAB/JCAP) Approve Date 05-Apr-2018

### **Product Attributes**

Attributes	Qual Device: TAS2557YZ	QBS Package Reference: CD3230A0YFF	QBS Package Reference: <u>LM3566A0YFFR</u>
Assembly Site	JCAP	JCAP	CLARK
Package Family	DSBGA	DSBGA	DSBGA
Flammability Rating	UL 94 V-0	UL 94 V-0	UL 94 V-0
Wafer Fab Supplier	RFAB	RFAB	RFAB
Wafer Process	LBC8LV	LBC7	LBC8LV

<sup>-</sup> QBS: Qual By Similarity

### **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: <u>TAS2557YZ</u>	QB\$ Package Reference: CD3230A0YFF	QB\$ Package Reference: <u>LM3566A0YFFR</u>
HAST	Biased HAST, 130C/85%RH	96 Hours	-	1/77/0	1/77/0
HBM	ESD - HBM	2500 V	-	-	1/3/0
CDM	ESD - CDM	1500 V	-	-	1/3/0
HTOL	Life Test, 125C	1000 Hours	-	1/77/0	1/77/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	-	3/231/0	1/77/0
LU	Latch-up	(per JESD78)	-	-	1/6/0
PD	Physical Dimensions	-	-	3/15/0	-
SBS	Bump-Shear	Bumps	1/36/0	3/150/0	-
TC	Temperature Cycle, -55/125C	700 Cycles	1/77/0	3/231/0	-
TC	Temperature Cycle, -65/150C	500 Cycles	-	-	1/77/0
UHAST	Unbiased HAST, 130C/85%RH	96 Hours	1/77/0	3/231/0	1/77/0
The followi The followi The followi	ining was performed for Autoclave, Unbiase ng are equivalent HTOL options based on a ng are equivalent HTSL options based on ang are equivalent Temp Cycle options per J n vironmental data is available at TT's exterr	n activation energy of 0.70 n activation energy of 0.70 ESD47:-55C/125C/700	eV : 125C/1k Hours, 140C/480 Ho eV : 150C/1k Hours, and 170C/420 Cycles and -65C/150C/500 Cycles	ours, 150C/300 Hours, and 155C/240 H D Hours	Hours

Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

<sup>-</sup> Qual Device TAS2557YZ is qualified at LEVEL1-260C



## Qualification Report

# TAS2557YZ (RFAB/DMOS6 MFF) Approve Date 19-Apr-2018

#### **Product Attributes**

Attributes	Qual Device: <u>TAS2557YZ</u>	QBS Process Reference: TAS2552YFF	QBS Process Reference: <u>TAS2553YFF</u>
Assembly Site	CLARK-AT	CLARK-AT	CLARK-AT
Package Family	DSBGA	DSBGA	DSBGA
Flammability Rating	UL 94 V-0	UL 94 V-0	UL 94 V-0
Wafer Fab Supplier	RFAB/DMOS6 (MFF)	RFAB/DMOS6 (MFF)	RFAB/DMOS6 (MFF)
Wafer Process	LBC8LV	LBC8LV	LBC8LV

<sup>-</sup> QBS: Qual By Similarity

#### **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: <u>TAS2557YZ</u>	QBS Process Reference: TAS2552YFF	QBS Process Reference: TAS2553YFF
ED	Electrical Characterization	Per Datasheet Parameters	1/30/0	-	Pass
ELFR	Early Life Failure Rate, 125C	48 Hours	-	-	3/3000/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	3/231/0	-
HBM	ESD - HBM	4000 V	1/3/0	-	-
CDM	ESD - CDM	1500 V	1/3/0	-	3/9/0
HTOL	Life Test, 125C	1000 Hours	-	-	3/231/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	-	3/228/0	-
LU	Latch-up	(per JESD78)	1/6/0	-	3/18/0
SBS	Bump Shear	Solder Bumps	1/36/0	3/108/0	-
TC	Temperature Cycle, -55/125C	700 Cycles	-	3/231/0	-
UHAST	Unbiased HAST, 130C/85%RH	96 Hours	-	3/228/0	-

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

THIS INFORMATION RELATING TO QUALITY AND RELIABILITY IS PROVIDED "AS IS." Product information detailed in this report may not accurately reflect TTs current product materials, processes and testing used in the construction of the TI products. Customers are solely responsible to conduct sufficient engineering and additional qualification testing to determine whether a device is suitable for use in their applications. Using TI products outside limits stated in TI's datasheet may void TI's warranty. See TI's Terms of Sale at "http://www.ti.com/lsds/ti/legal/termsofsale.page'

For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

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USA	PCNAmericasContact@list.ti.com
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<sup>-</sup> Qual Device TAS2557YZ is qualified at LEVEL1-260C

<sup>-</sup> Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

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